

## Quality Information for Product Type BZX79-B6V2

Quality and reliability data provided by Nexperia Semiconductors is intended to be a non-binding estimate of product performance only. It does not imply that any performance levels reflected in such data can be met if the product is operated outside the conditions expressly stated in the latest published data sheet for a device or in your application.

### Quick reference

Information	Content
Device Type	BZX79-B6V2
Ordering Information (12NCs)	9331 668 30113, 9331 668 30133, 9331 668 30143
Qualification Grade	non automotive
Package	SOD27 (ALF2)
Waferfab	Wafer foundry PHENITEC
Assembly	Subcontractor Tak Cheong
ESD HBM	> 8000 V
Calculated Failure Rate	4.43 FIT
MTBF/MTTF	2.26E+08 hours

### Explanation

Automotive qualified products are in accordance with the AEC-Q101.

Electrostatic Discharge (ESD) tests are performed as described in the AEC-Q101 with each 3 positive and 3 negative pulses for each stress voltage level.

Test considered for FIT calculation: High Temperature Reverse Bias (HTRB, AEC-Q101 Test # 5). The parameters for calculation of FIT and MTBF/MTTF are as follows: Confidence level 60%, junction temperature derated to 55 °C, activation energy 0.7 eV, test time 168 - 1000 hrs.

For discrete semiconductor devices the Mean Time Between Failure (MTBF) is replaced by the Mean Time To Failure (MTTF) acronym. MTTF is calculated from the Intrinsic Failure Rate.